

FDMC88884 N-Channel Power Trench[®] MOSFET 30 V, 15 A, 19 m Ω

Features

- Max $r_{DS(on)}$ = 19 m Ω at V_{GS} = 10 V, I_D = 9.0 A
- Max $r_{DS(on)}$ = 30 m Ω at V_{GS} = 4.5 V, I_D = 7.2 A
- High performance technology for extremely low r_{DS(on)}
- Termination is Lead-free and RoHS Compliant

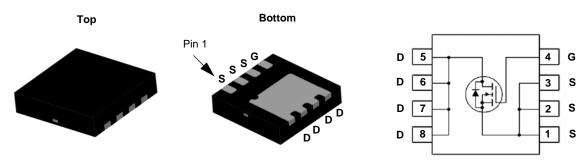


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

Application

- High side in DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



MLP 3.3x3.3

MOSFET Maximum Ratings $T_A = 25 \ ^{\circ}C$ unless otherwise noted

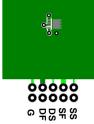
Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		15		
	-Continuous (Silicon limited) $T_{C} = 25 \text{ °C}$			24		
	-Continuous	T _A = 25 °C	(Note 1a)	9.0	Α	
	-Pulsed			40		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	24	mJ	
P _D	Power Dissipation	T _C = 25 °C		18		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C		

$R_{\theta JC}$	Thermal Resistance, Junction to Case	6.6	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a	l) 53	C/VV

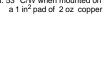
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8884	FDMC8884	MLP 3.3x3.3	13 "	12 mm	3000 units

	Test Conditions	Min	Тур	Max	Units
cteristics					
Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	30			V
Breakdown Voltage Temperature	$I_D = 250 \ \mu$ A, referenced to 25 °C		22		mV/°C
Coefficient				4	
Zero Gate Voltage Drain Current	T ₁ = 125 °C			1 250	μA
Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
cteristics					
	$V_{00} = V_{00}$ $I_0 = 250 \mu A$	14	19	25	V
-		1.4	1.5	2.0	v
Temperature Coefficient	$I_D = 250 \ \mu A$, referenced to 25 °C		-6		mV/°C
			16	19	mΩ
Static Drain to Source On Resistance			22	30	
			22	30	
Forward Transconductance	$V_{DD} = 5 V, I_{D} = 9.0 A$		24		S
Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		513 110 76	685 150 115	pF pF pF
Gate Resistance			1.4	2.1	Ω
Characteristics Turn-On Delay Time			6	2.1	Ω
Characteristics	V _{DD} = 15 V, I _D = 9.0 A,			I	I
Characteristics Turn-On Delay Time	$V_{DD} = 15 V, I_D = 9.0 A,$ $V_{GS} = 10 V, R_{GEN} = 6 Ω$		6	12	ns
Characteristics Turn-On Delay Time Rise Time			6 2	12 10	ns ns
Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$		6 2 15	12 10 27	ns ns ns
Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{GS} = 10$ V, $R_{GEN} = 6$ Ω $V_{GS} = 0$ V to 10 V $V_{GS} = 0$ V to 4.5 V $V_{DD} = 15$ V		6 2 15 2	12 10 27 10	ns ns ns ns
Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		6 2 15 2 10	12 10 27 10 14	ns ns ns nC
Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10$ V, $R_{GEN} = 6$ Ω $V_{GS} = 0$ V to 10 V $V_{GS} = 0$ V to 4.5 V $V_{DD} = 15$ V		6 2 15 2 10 5.0	12 10 27 10 14	ns ns ns nC nC
Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge	$V_{GS} = 10$ V, $R_{GEN} = 6$ Ω $V_{GS} = 0$ V to 10 V $V_{GS} = 0$ V to 4.5 V $V_{DD} = 15$ V		6 2 15 2 10 5.0 1.8	12 10 27 10 14	ns ns ns nC nC
Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge Ince Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V}$ $I_D = 9.0 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 9.0 \text{ A}$ (Note 2)		6 2 15 2 10 5.0 1.8	12 10 27 10 14	ns ns nC nC nC nC
Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 9.0 \text{ A}$		6 2 15 2 10 5.0 1.8 2.2	12 10 27 10 14 7.0	ns ns ns nC nC
Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge Ince Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V}$ $I_D = 9.0 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 9.0 \text{ A}$ (Note 2)		6 2 15 2 10 5.0 1.8 2.2 0.86	12 10 27 10 14 7.0	ns ns nC nC nC nC
	Zero Gate Voltage Drain Current Gate to Source Leakage Current Cteristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance	Zero Gate Voltage Drain Current $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ $T_J = 125 ^{\circ}\text{C}$ Gate to Source Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ Cteristics Gate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$ Gate to Source Threshold Voltage Temperature Coefficient $I_D = 250 \mu\text{A}, \text{ referenced to } 25 ^{\circ}\text{C}$ Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 9.0 \text{ A}$ VGS = 10 V, I_D = 9.0 A, T_J = 125 ^{\circ}\text{C}Forward Transconductance $V_{DD} = 5 \text{ V}, I_D = 9.0 \text{ A}$ Characteristics Input Capacitance $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 125 \text{ C}$	Zero Gate Voltage Drain Current $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ $T_J = 125 °C$ Gate to Source Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ cteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250 \mu \text{ A}$ Gate to Source Threshold Voltage $I_D = 250 \mu \text{ A}, \text{ referenced to } 25 °C$ Temperature Coefficient $V_{GS} = 10 \text{ V}, I_D = 9.0 \text{ A}$ Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 9.0 \text{ A}$ Forward Transconductance $V_{DD} = 5 \text{ V}, I_D = 9.0 \text{ A}$ CharacteristicsInput Capacitance $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 125 °C$ Output Capacitance $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 10 \text{ V}, I_D = 10 \text{ A}$	Zero Gate Voltage Drain Current $V_{DS} = 24 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $T_J = 125 \text{ °C}$ Gate to Source Leakage Current $V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ $T_J = 125 \text{ °C}$ CteristicsGate to Source Threshold Voltage $V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 250 \text{ µA}$ 1.4 1.9 Gate to Source Threshold Voltage $I_D = 250 \text{ µA}, \text{ referenced to } 25 \text{ °C}$ -6 Temperature Coefficient $I_D = 250 \text{ µA}, \text{ referenced to } 25 \text{ °C}$ -6 Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, \text{ I}_D = 9.0 \text{ A}$ 16 $V_{GS} = 10 \text{ V}, \text{ I}_D = 9.0 \text{ A}, \text{ T}_J = 125 \text{ °C}$ 22 Forward Transconductance $V_{DD} = 5 \text{ V}, \text{ I}_D = 9.0 \text{ A}$ 24 CharacteristicsInput Capacitance $V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ 110}$	Zero Gate Voltage Drain Current $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ 1 $T_J = 125 \text{ °C}$ 250Gate to Source Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ ± 100 cteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250 \mu \text{ A}$ 1.4 1.9 2.5 Gate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250 \mu \text{ A}$ 1.4 1.9 2.5 Gate to Source Threshold Voltage $I_D = 250 \mu \text{ A}, \text{ referenced to } 25 \text{ °C}$ -6 -6 Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 9.0 \text{ A}$ 16 19 $V_{GS} = 10 \text{ V}, I_D = 9.0 \text{ A}, T_J = 125 \text{ °C}$ 22 30 Forward Transconductance $V_{DD} = 5 \text{ V}, I_D = 9.0 \text{ A}, T_J = 125 \text{ °C}$ 22 CharacteristicsInput Capacitance $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, I_10$ 513 0 utput Capacitance $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, I_110$ 150



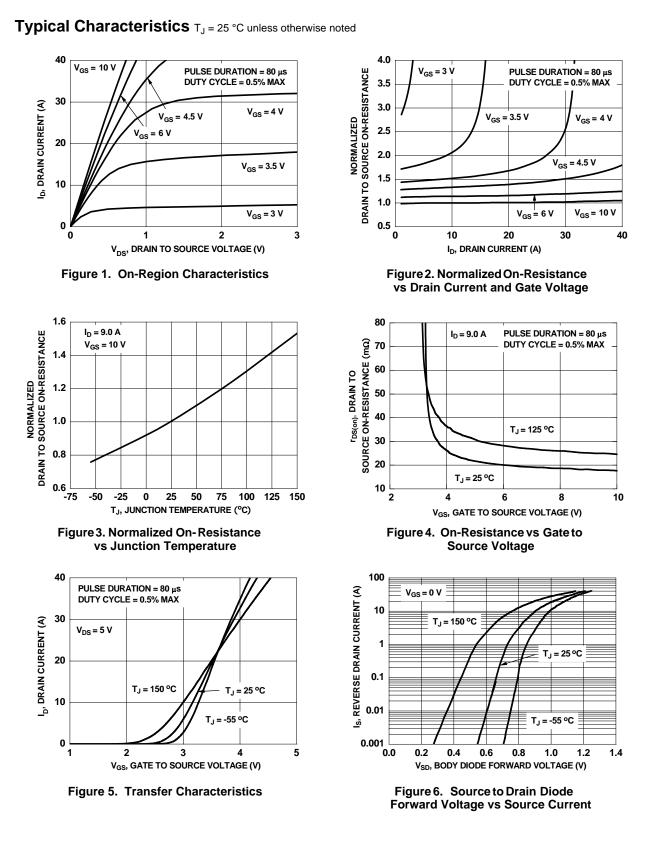
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.



3. E_{AS} of 24 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 7 A, V_{DD} = 30 V, V_{GS} = 10 V. 100% test at L = 3 mH, I_{AS} = 4 A .

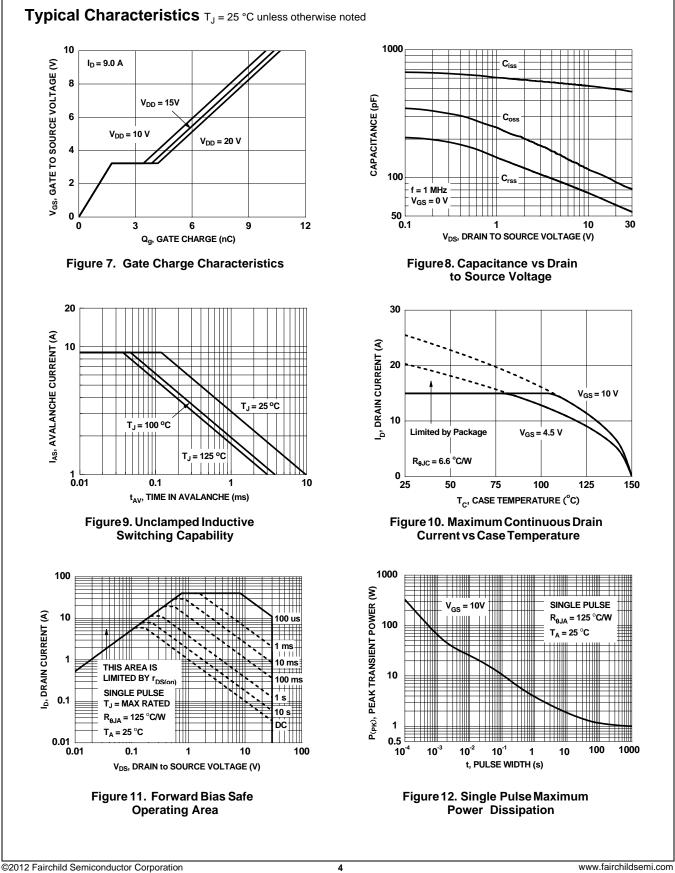


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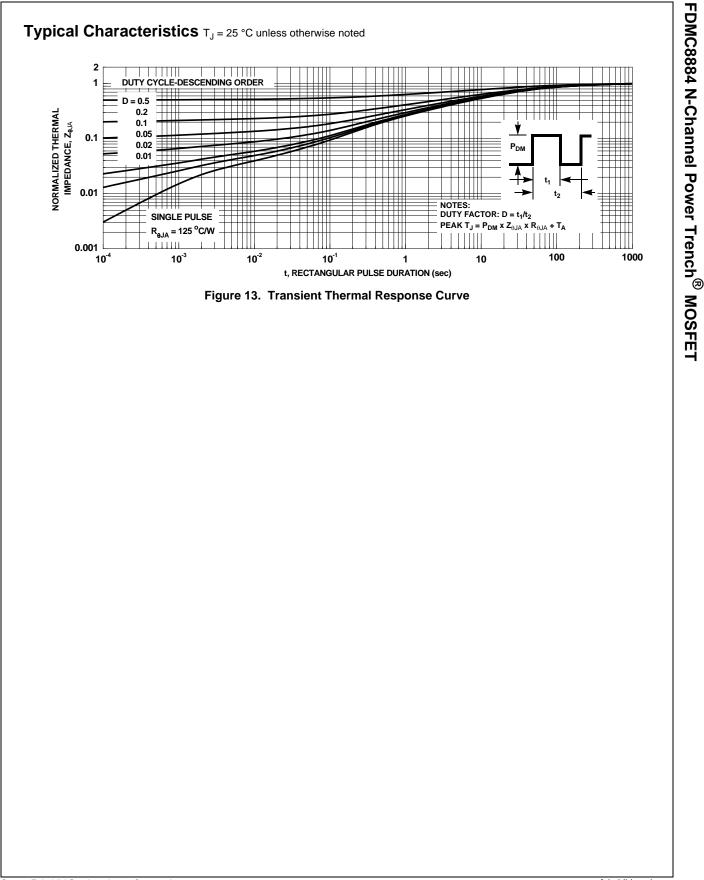
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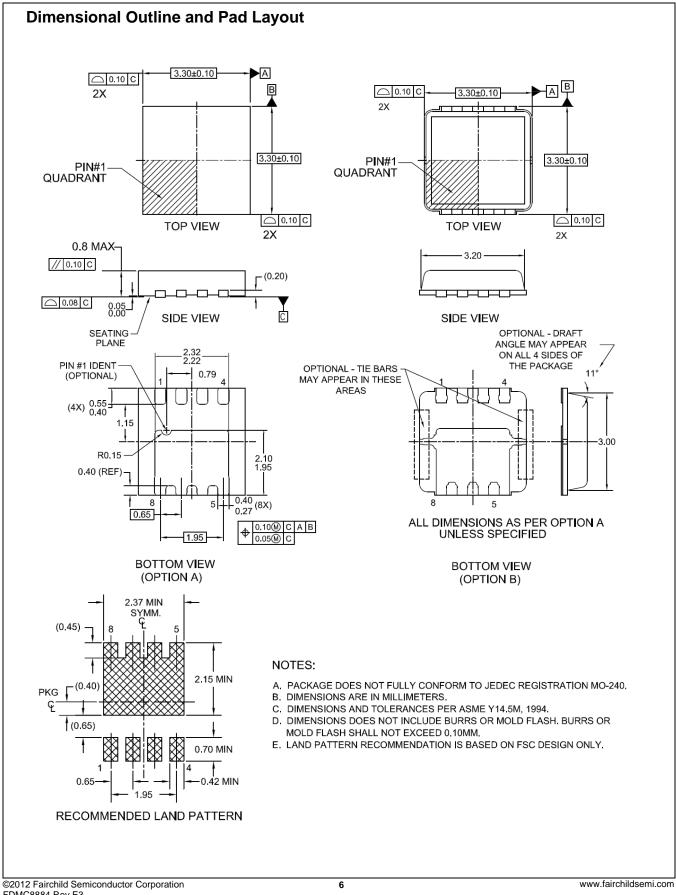
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